

PGB2 0201 Series





Equivalent Circuits



Product Characteristics

| Part Number | Lines Protected | Component Package | |
|--------------|-----------------|-------------------|--|
| PGB2010201KR | 1 | 0201 | |

Description

PULSE-GUARD® ESD Suppressors help protect sensitive electronic equipment against electrostatic discharge (ESD).

They use polymer composite materials to suppress fastrising ESD transients (as specified in IEC 61000-4-2), while adding virtually no capacitance to the circuit.

They supplement the on-chip protection of integrated circuitry and are best suited for low-voltage, high-speed applications where low capacitance is important to ensure minimal interference of data signal integrity.

The new and ultra-small surface mount PGB2 0201 series offers a RoHS Compliant, Halogen Free, and 100% Lead Free circuit protection alternative.

Features

- Lead-free, Halogen-free and RoHS compliant
- Ultra-low capacitance
- Low leakage current
- Fast response time
- One line of protection
- Bi-directional
- Withstands multiple ESD strikes
- Compatible with pick-and-place processes

Applications

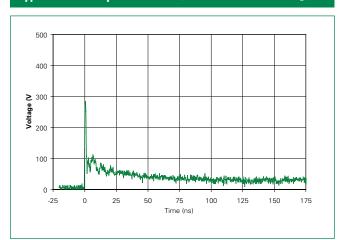
- HDTV Hardware
- Laptop/Desktop Computer
- Network Hardware
- HDMI/USB 3.0
- Computer Peripherals
- Digital Camera
- External Storage
- Set-Top Box

Electrical Characteristics

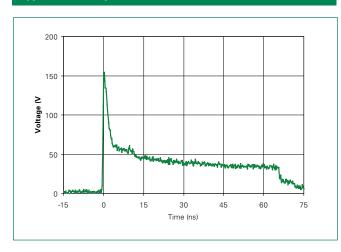
| Specification | PGB2010201 | Notes |
|------------------------------------------------------------------------------------------------------|--------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| ESD Capability: IEC 61000-4-2 Direct Discharge (typical) IEC 61000-4-2 Air Discharge (typical) | 8kV 10kV - 15kV | The ESD capability measured by direct and air discharge method is subject to testing equipment and conditions. Numerous factors could affect the reliability and reproducibility of the direct and air discharge test results. |
| Trigger Voltage (typical) Clamping Voltage (typical) | 400V 55V | Measured per IEC 61000-4-2 8kV Direct Discharge Method |
| Rated Voltage (maximum) | 12VDC, max | |
| Capacitance (typical) | 0.07 pF, typical | Measured at 250 MHz |
| Response Time | <1nS | Measured per IEC 61000-4-2 8kV Direct Discharge Method |
| Leakage Current (typical) | <1nA | Measured at 12 VDC |
| ESD Pulse Withstand | 1000 pulses min | Some shifting in characteristics may occur when tested over multiple pulses at a very rapid rate |

PULSE-GUARD® ESD Suppressors

Typical ESD Response Curve (8 kV IEC 61000-4-2 Direct Discharge)

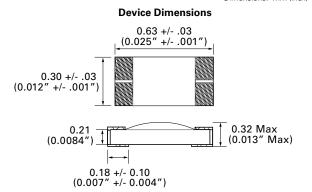


Typical TLP Response Curve (500 V Direct Discharge)

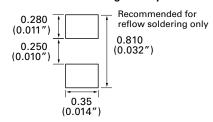


Dimensions

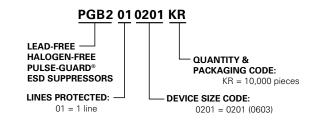
Dimensions: mm (inch)



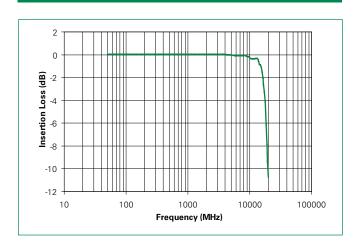
Recommended Soldering Pad Layout



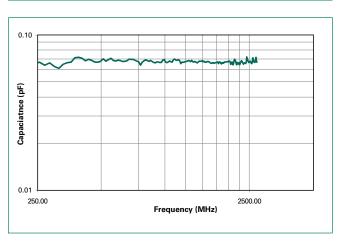
Part Numbering System



Typical Insertion Loss



Typical Device Capacitance



PULSE-GUARD® ESD Suppressors





Physical Specifications

| Materials | Body: Epoxy / Glass Substrate Terminations: Cu/Ni/Sn | |
|---------------------------------------------------------------------------------------------------------|------------------------------------------------------|--|
| Device Weight | 0.349 mg | |
| Solderability | MIL-STD-202, Method 208 | |
| Soldering Parameters Wave solder - 260°C, 10 seconds maximum Reflow solder - 260°C, 30 seconds maximum | | |

Design Consideration

Because of the fast rise-time of the ESD transient, proper placement of PULSE-GUARD® suppressors are a key design consideration to achieving optimal ESD suppression.

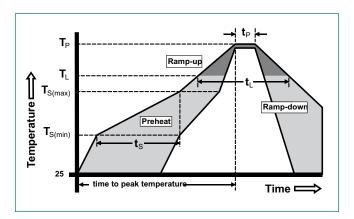
The devices should be placed on the circuit board as close to the source of the ESD transient as possible. Install PULSE-GUARD® suppressors (connected from signal/data line to ground) directly behind the connector so that they are the first board-level circuit component encountered by the ESD transient.

Environmental Specifications

| Operating Temperature | -65°C to +125°C |
|--------------------------------------------------|-------------------------------------------------------------------------|
| Biased Humidity: Biased Heat: | 40°C, 95% RH, 1000 hours 85°C, 1000 hours |
| Thermal Shock | MIL-STD-202, Method 107, -65°C to 125°C, 30 min. cycle, 10 cycles |
| Vibration | MIL-STD-202, Method 201 |
| Chemical Resistance | MIL-STD-202, Method 215 |
| Solder Leach Resistance and Terminal Adhesion | IPC/EIA J-STD-002 |

Soldering Parameters

| Reflow Condition | | Pb – Free assembly |
|-----------------------------------------------------------------|-------------------------------------------|--------------------|
| | -Temperature Min (T _{s(min)}) | 150°C |
| Pre Heat | -Temperature Max (T _{s(max)}) | 200°C |
| | -Time (min to max) (t _s) | 60 – 180 seconds |
| Average ra | amp up rate (Liquidus Temp k | 3°C/second max |
| T _{S(max)} to T _L | - Ramp-up Rate | 3°C/second max |
| Reflow | -Temperature (T _L) (Liquidus) | 217°C |
| nellow | -Temperature (t _L) | 60 – 150 seconds |
| PeakTemp | perature (T _P) | 260°C |
| Time within 5°C of actual peak Temperature (t _p) | | 10 – 30 seconds |
| Ramp-down Rate | | 6°C/second max |
| Time 25°C to peakTemperature (T _P) | | 8 minutes max |



Notes:

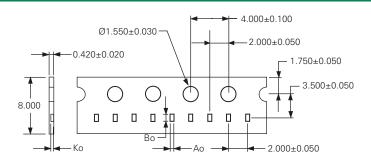
- PGB2 Series recommended for reflow soldering only
- Recommended profile based on IPC/JEDED J-STD-020C
- For recommended soldering pad layout dimensions, please refer to Dimensions section of this data sheet

PULSE-GUARD® ESD Suppressors

Packaging

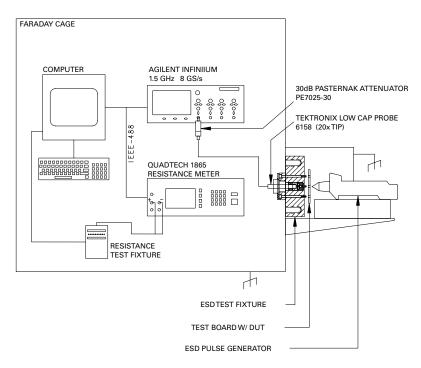
| Part Number | Quantity & Packaging Code | Quantity | Packaging Option | Packaging Specification |
|-------------|------------------------------|----------|-----------------------|---------------------------------------------------|
| PGB2010201 | KR | 10000 | Tape & Reel (7" reel) | Carrier Tape: 8mm, paper Reel: 7" (178mm) reel |

Tape and Reel Specifications



| Description | 0201 Series (mm) |
|--------------------------------|---------------------|
| A ₀ - Pocket Width | 0.360±0.020 |
| B ₀ - Pocket Height | 0.680±0.020 |
| K₀ - Pocket Depth | 0.300±0.020 |

Typical ESD Pulse Test Setup



Notes:

- QuadQuadTech 1865 High Resistance Meter: Measures insulation resistance values
- KeyTek MiniZap ESD simulator with IEC tip: Simulates 8kV, direct discharge ESD event per IEC 61000-4-2
- Faraday cage: Shields the acquisition equipment from the electromagnetic fields generated by the simulator
- Agilent 2.25 GHz 54846A Oscilloscope: Records the voltage waveform from the device under test
- -Tektronix 6158 probe with 30dB attenuator: Transmits the waveform from the device to the oscilloscope